onsemi

MOSFET – N-Channel, UniFET[™] 60 V, 55 A, 22 mΩ

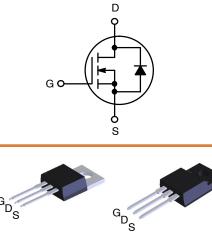
FDP55N06 / FDPF55N06

Description

UniFET MOSFET is **onsemi**'s high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.

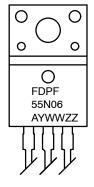
Features

- $R_{DS(on)} = 22 \text{ m}\Omega \text{ (Typ.)} @ V_{GS} = 10 \text{ V}, I_D = 27.5 \text{ A}$
- Low Gate Charge (Typ. 30 nC)
- Low C_{rss} (Typ. 60 pF)
- 100% Avalanche Tested



TO-220-3LD TO-220 Fullpack, 3-Lead CASE 340AT / TO-220F-3SG CASE 221AT

MARKING DIAGRAM



FDP55N06,

FDPF55N06	= Specific Device Code
А	= Assembly Location
YWW	= Date Code (Year & Week)
ZZ	= Assembly Lot

ORDERING INFORMATION

Device	Package	Shipping		
FDP55N06	TO-220	1000 Units / Tube		
FDPF55N06	TO-220F	1000 Units / Tube		

Symbol	Parameter		FDP55N06	FDPF55N06	Unit
V _{DSS}	Drain to Source Voltage		60	60	V
Ι _D	Drain Current -	– Continuous (T _C = 25°C) – Continuous (T _C = 100°C)	55 34.8	55* 34.8*	Α
I _{DM}	Drain Current	– Pulsed (Note 1)	220	220*	А
V _{GSS}	Gate-Source Voltage		±25	±25	V
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		480	480	mJ
I _{AR}	Avalanche Current (Note 1)		55	55	А
E _{AR}	Repetitive Avalanche Energy (Note 1)		11.4	11.4	mJ
dv/dt	Peak Diode Recovery dv/dt (Note	3)	4.5	4.5	V/ns
P _D	Power Dissipation	(T _C = 25°C) – Derate Above 25°C	114 0.9	48 0.4	W W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	-55 to +150	°C
ΤL	Maximum Lead Temperature for S	oldering, 1/8" from Case for 5 Second	300	300	°C

ABSOLUTE MAXIMUM RATINGS (T_C = 25° C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. *Drain current limited by maximum junction temperature 1. Repetitive Rating: Pulse width limited by maximum junction temperature. 2. L = 5.6 mH, I_{AS} = 55 A, V_{DD} = 50 V, R_G = 25 Ω , Starting T_J = 25°C 3. I_{SD} ≤ 55 A, di/dt ≤ 200 A/µs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C

THERMAL CHARACTERISTICS

C_{rss}

Symbol	Parameter	FDP55N06	FDPF55N06	Unit
Rejc	Thermal Resistance, Junction-to-Case, Max.	1.1	2.58	°C/W
Rejs	Thermal Resistance, Junction-to-sink, Typ.	0.5	-	°C/W
Reja	Thermal Resistance, Junction-to-Ambient, Max.	62.5	62.5	°C/W

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Reverse Transfer Capacitance

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFF CHARAC	TERISTICS					
BV _{DSS}	Drain-Source Breakdown Voltage	I_{D} = 250 μ A, V_{GS} = 0 V	60	-	-	V
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C	_	0.05	_	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μA
		V_{DS} = 48 V, T_{C} = 150°C	-	-	10	
I _{GSSF}	Gate-Body Leakage Current, Forward	V_{GS} = 20 V, V_{DS} = 0 V	-	-	100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	-	-	-100	nA
ON CHARACT	ERISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2.0	-	4.0	V
R _{DS(on)}	Static Drain-Source On Resistance	V_{GS} = 10 V, I_{D} = 27.5 A	-	0.018	0.022	Ω
9 FS	Forward Transconductance	$V_{DS} = 25 \text{ V}, \text{ I}_{D} = 27.5 \text{ A}$	-	33	-	S
DYNAMIC CHA	ARACTERISTICS					
C _{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1 MHz	-	1160	1510	pF
Coss	Output Capacitance		-	375	490	pF

60

_

90

pF

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted) (continued)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
SWITCHING C	HARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 30 \text{ V}, \text{ I}_{D} = 55 \text{ A},$	-	30	65	ns
t _r	Turn-On Rise Time	R _G = 25 Ω (Note 4)	-	130	265	ns
t _{d(off)}	Turn-Off Delay Time		-	70	150	ns
t _f	Turn-Off Fall Time		-	95	195	ns
Q _{g(tot)}	Total Gate Charge at 10V	V _{DD} = 48 V, I _D = 55 A, V _{GS} = 10 V (Note 4)	-	30	37	nC
Q _{gs}	Gate-Source Gate Charge		-	6.5	-	nC
Q _{gd}	Gate-Drain Charge		-	7.5	-	nC
DRAIN-SOUR	CE DIODE CHARACTERISTICS					
I _S	Maximum Continuous Drain-Source Diode Forward Current		-	_	55	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	220	А
V _{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0 V, I_{SD} = 55 A$	-	_	1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 55 A dI _F /dt = 100 A/µs	-	40	-	ns
Q _{rr}	Reverse Recovery Charge		-	55	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature.

TYPICAL CHARACTERISTICS

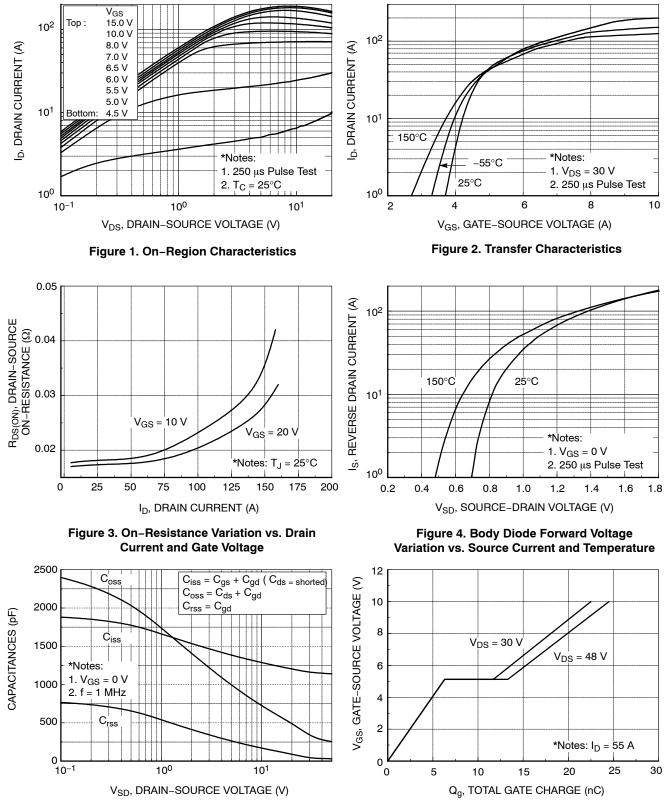
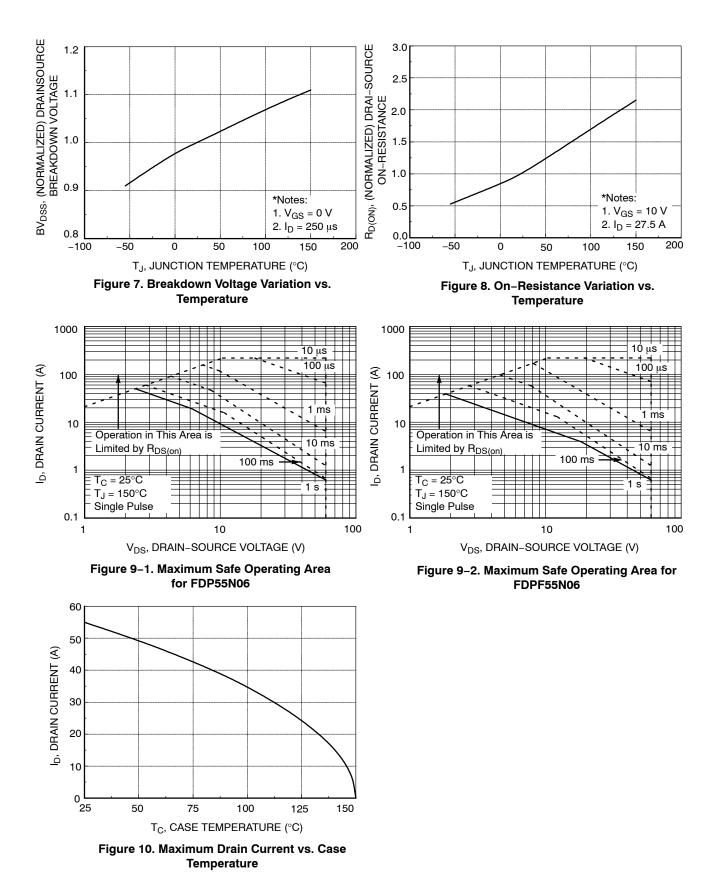


Figure 5. Capacitance Characteristics

Figure 6. Gate Charge Characteristics

TYPICAL CHARACTERISTICS (continued)



TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)

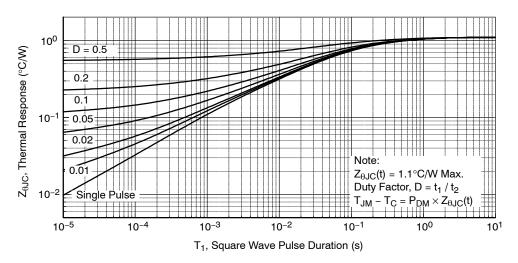


Figure 11–1. Transient Thermal Response Curve for FDP55N06

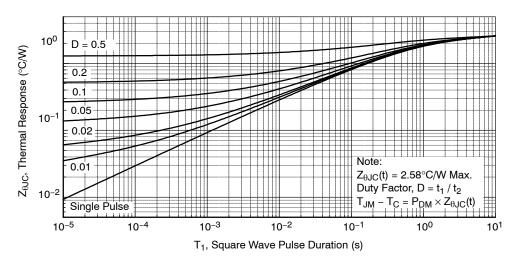


Figure 11–2. Transient Thermal Response Curve for FDPF55N06

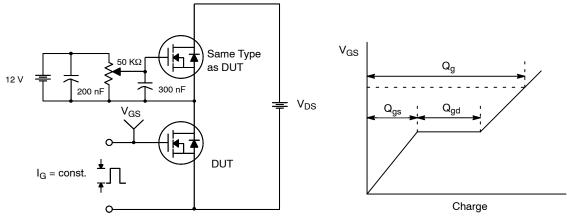


Figure 12. Gate Charge Test Circuit & Waveform

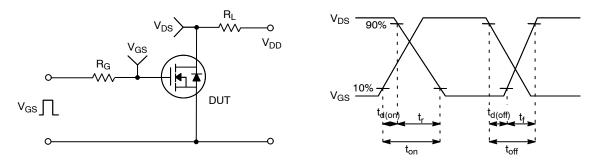


Figure 13. Resistive Switching Test Circuit & Waveforms

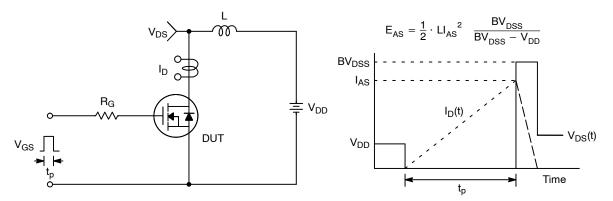


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

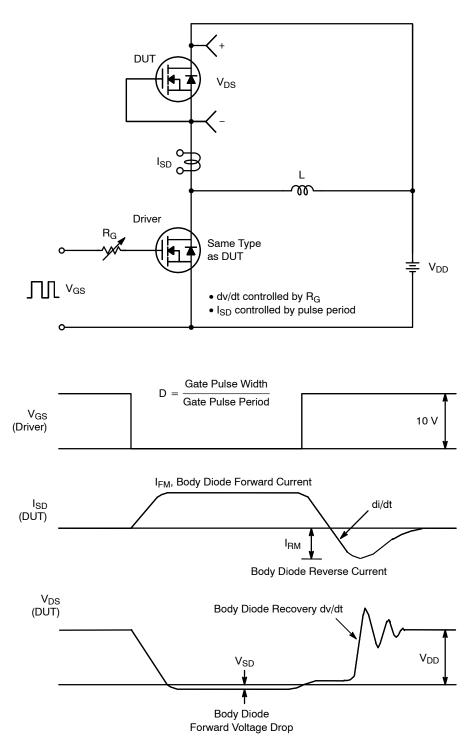
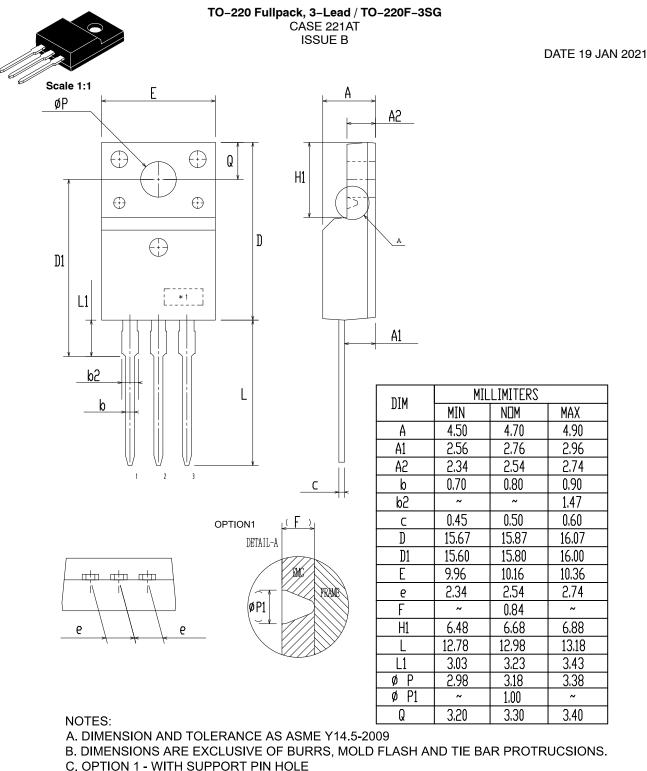


Figure 15. Peak Recovery dv/dt Test Circuit & Waveforms

UniFET is trademark of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries.

onsemi

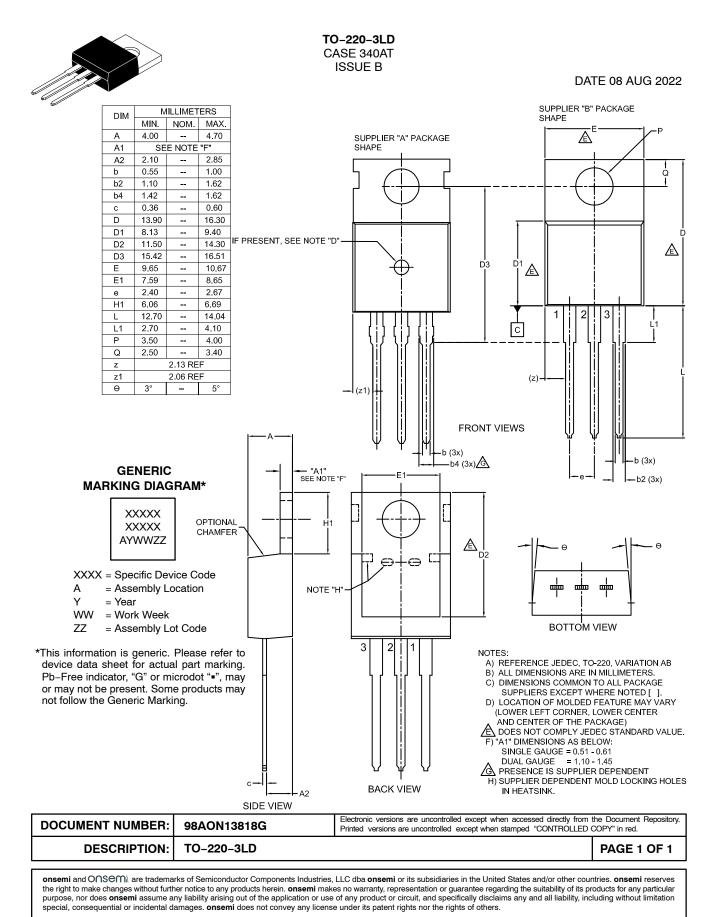


OPTION 2 - NO SUPPORT PIN HOLE

DOCUMENT NUMBER:	98AON67439E Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.				
DESCRIPTION:	TO-220 FULLPACK, 3-LEAD / TO-220F-3SG		PAGE 1 OF 1		

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.





onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>